

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









# **C3D10065A**Silicon Carbide Schottky Diode Z-REC® RECTIFIER

# $V_{RRM}$ = 650 V $I_{F}(T_{c}=135^{\circ}C)$ = 14.5 A $Q_{c}$ = 24 nC

#### **Features**

- 650-Volt Schottky Rectifier
- Zero Reverse Recovery Current
- Zero Forward Recovery Voltage
- High-Frequency Operation
- Temperature-Independent Switching Behavior
- · Extremely Fast Switching
- Positive Temperature Coefficient on V<sub>F</sub>

## **Benefits**

- Replace Bipolar with Unipolar Rectifiers
- Essentially No Switching Losses
- Higher Efficiency
- · Reduction of Heat Sink Requirements
- Parallel Devices Without Thermal Runaway

## **Applications**

- Switch Mode Power Supplies
- Power Factor Correction
- Motor Drives

## **Package**







TO-220-2





Part Number	Package	Marking
C3D10065A	T0-220-2	C3D10065

## **Maximum Ratings** ( $T_c = 25$ °C unless otherwise specified)

Symbol	Parameter	Value	Unit	Test Conditions	Note
$V_{_{\mathrm{RRM}}}$	Repetitive Peak Reverse Voltage	650	٧		
V <sub>RSM</sub>	Surge Peak Reverse Voltage	650	٧		
V <sub>DC</sub>	DC Blocking Voltage	650	٧		
I <sub>F</sub>	Continuous Forward Current	30 14.5 10	А	T <sub>c</sub> =25°C T <sub>c</sub> =135°C T <sub>c</sub> =153°C	Fig. 3
I <sub>FRM</sub>	Repetitive Peak Forward Surge Current	46 31	А	$T_c$ =25°C, $t_p$ = 10 ms, Half Sine Wave $T_c$ =110°C, $t_p$ =10 ms, Half Sine Wave	
I <sub>FSM</sub>	Non-Repetitive Peak Forward Surge Current	90 71	А	$T_c$ =25°C, $t_p$ = 10 ms, Half Sine Wave $T_c$ =110°C, $t_p$ = 10 ms, Half Sine Wave	Fig. 8
I <sub>F,Max</sub>	Non-Repetitive Peak Forward Surge Current	860 680	Α	$T_c$ =25°C, $t_p$ = 10 $\mu$ s, Pulse $T_c$ =110°C, $t_p$ = 10 $\mu$ s, Pulse	Fig. 8
P <sub>tot</sub>	Power Dissipation	136.5 59	W	T <sub>c</sub> =25°C T <sub>c</sub> =110°C	Fig. 4
$T_{J}$ , $T_{stg}$	Operating Junction and Storage Temperature	-55 to +175	°C		
	TO-220 Mounting Torque	1 8.8	Nm lbf-in	M3 Screw 6-32 Screw	



## **Electrical Characteristics**

Symbol	Parameter	Тур.	Max.	Unit	Test Conditions	Note
V <sub>F</sub>	Forward Voltage	1.5 2.0	1.8 2.4	V	I <sub>F</sub> = 10 A T <sub>J</sub> =25°C I <sub>F</sub> = 10 A T <sub>J</sub> =175°C	Fig. 1
I <sub>R</sub>	Reverse Current	12 24	60 220	μΑ	V <sub>R</sub> = 650 V T <sub>J</sub> =25°C V <sub>R</sub> = 650 V T <sub>J</sub> =175°C	Fig. 2
Q <sub>c</sub>	Total Capacitive Charge	24		nC	$V_R = 400 \text{ V, } I_F = 10 \text{ A}$ $di/dt = 500 \text{ A/}\mu\text{s}$ $T_J = 25^{\circ}\text{C}$	Fig. 5
С	Total Capacitance	460.5 44 40		pF	V <sub>R</sub> = 0 V, T <sub>J</sub> = 25°C, f = 1 MHz V <sub>R</sub> = 200 V, T <sub>J</sub> = 25°C, f = 1 MHz V <sub>R</sub> = 400 V, T <sub>J</sub> = 25°C, f = 1 MHz	Fig. 6
E <sub>c</sub>	Capacitance Stored Energy	3.6		μJ	V <sub>R</sub> = 400 V	Fig. 7

Note: This is a majority carrier diode, so there is no reverse recovery charge.

## **Thermal Characteristics**

Symbol	Parameter	Тур.	Unit	Note
$R_{_{\theta JC}}$	Thermal Resistance from Junction to Case	1.1	°C/W	Fig. 9

## **Typical Performance**

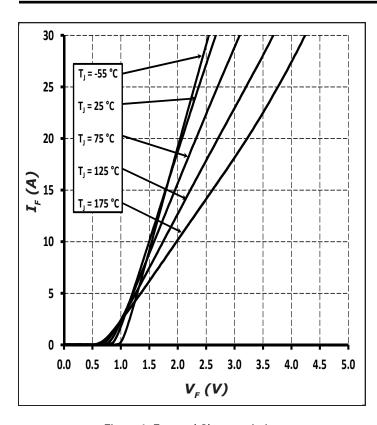


Figure 1. Forward Characteristics

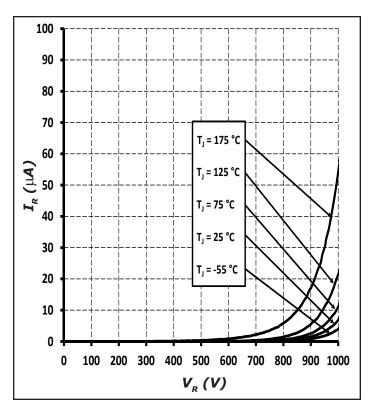
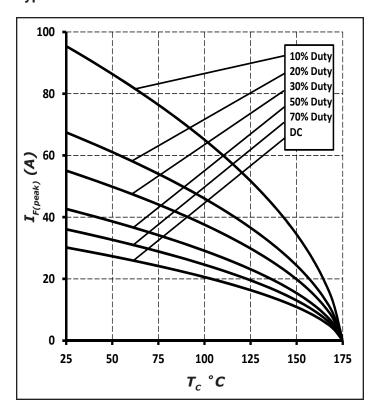


Figure 2. Reverse Characteristics



## **Typical Performance**



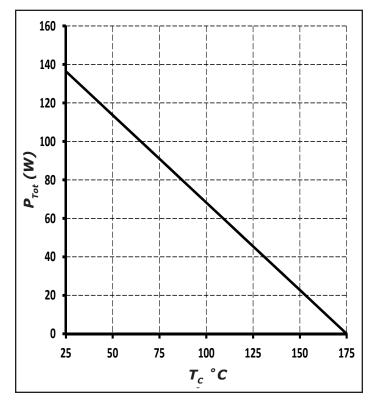


Figure 3. Current Derating

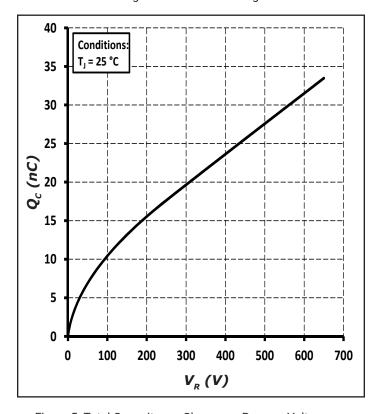


Figure 5. Total Capacitance Charge vs. Reverse Voltage

Figure 4. Power Derating

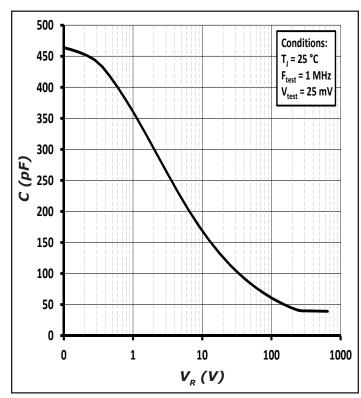
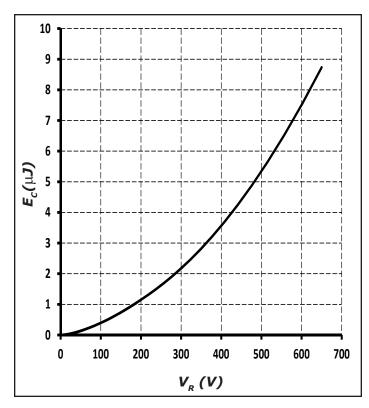
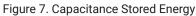


Figure 6. Capacitance vs. Reverse Voltage



## **Typical Performance**





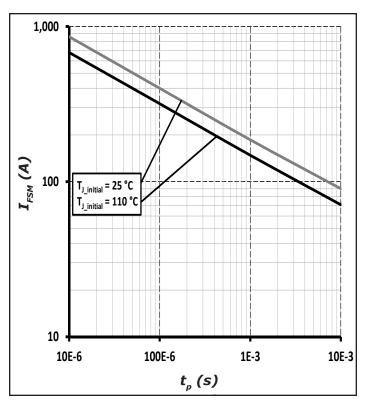


Figure 8. Non-repetitive peak forward surge current versus pulse duration (sinusoidal waveform)

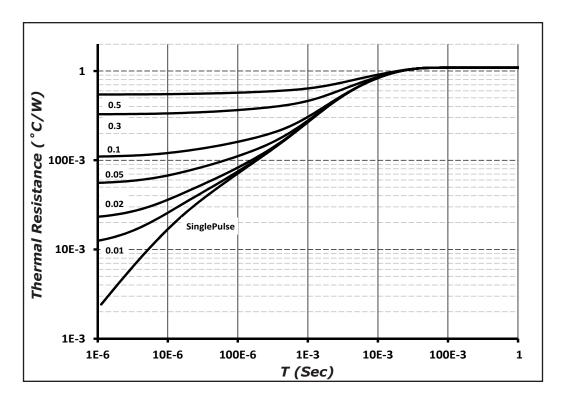
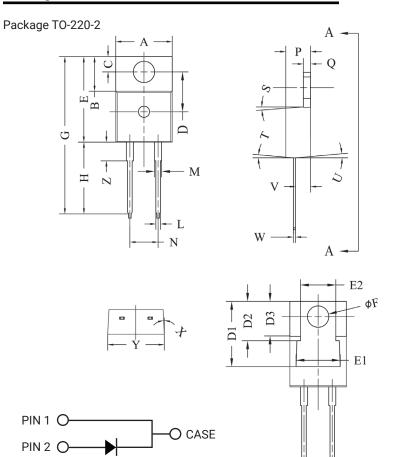


Figure 9. Transient Thermal Impedance



## **Package Dimensions**

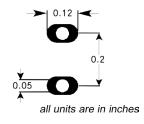


	Inc	hes	Millimeters		
POS	Min	Max	Min	Max	
А	.381	.410	9.677	10.414	
В	.235	.255	5.969	6.477	
С	.100	.120	2.540	3.048	
D	.223	.337	5.664	8.560	
D1	.457	490	11.60-12.45 typ		
D2	.2773	303 typ	7.04-7	.70 typ	
D3	.2442	252 typ	6.22-6	5.4 typ	
Е	.590	.615	14.986	15.621	
E1	.302	.326	7.68	8.28	
E2	.227	251	5.77	6.37	
F	.143	.153	3.632	3.886	
G	1.105	1.147	28.067	29.134	
Н	.500	.550	12.700	13.970	
L	.025	.036	.635	.914	
М	.045	.055	1.143	1.550	
N	.195	.205	4.953	5.207	
Р	.165	.185	4.191	4.699	
Q	.048	.054	1.219	1.372	
S	3°	6°	3°	6°	
Т	3°	6°	3°	6°	
U	3°	6°	3°	6°	
V	.094	.110	2.388	2.794	
W	.014	.025	.356	.635	
Х	3°	5.5°	3°	5.5°	
Y	.385	.410	9.779	10.414	
Z	.130	.150	3.302	3.810	

## NOTE:

1. Dimension L, M, W apply for Solder Dip Finish

## **Recommended Solder Pad Layout**



View A-A

TO-220-2

Part Number	Package	Marking		
C3D10065A	T0-220-2	C3D10065A		

Note: Recommended soldering profiles can be found in the applications note here: http://www.wolfspeed.com/power\_app\_notes/soldering





#### **Diode Model**

$$\begin{array}{c|c} - & & \\ \hline - & & \\ - & & \\ \hline - & & \\ - & & \\ \hline - & & \\ - & & \\ \hline - & & \\ - & & \\ \hline - & & \\ - & & \\ \hline - & & \\ - & & \\ \hline - & & \\ - & & \\ \hline - & & \\ - & & \\ \hline - & & \\ - & & \\ \hline - & &$$

$$Vf_{T} = V_{T} + If * R_{T}$$
 
$$V_{T} = 0.94 + (T_{J} * -1.3*10^{-3})$$
 
$$R_{T} = 0.044 + (T_{J} * 4.4*10^{-4})$$

Note: T<sub>j</sub> = Diode Junction Temperature In Degrees Celsius, valid from 25°C to 175°C

#### **Notes**

#### RoHS Compliance

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as implemented January 2, 2013.RoHS Declarations for this product can be obtained from your Wolfspeed representative or from the Product Ecology section of our website at http://www.wolfspeed.com/power/tools-and-support/product-ecology.

#### REACh Compliance

REACh substances of high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, please contact a Cree representative to insure you get the most up-to-date REACh SVHC Declaration. REACh banned substance information (REACh Article 67) is also available upon request.

This product has not been designed or tested for use in, and is not intended for use in, applications implanted into the human body
nor in applications in which failure of the product could lead to death, personal injury or property damage, including but not limited
to equipment used in the operation of nuclear facilities, life-support machines, cardiac defibrillators or similar emergency medical
equipment, aircraft navigation or communication or control systems, or air traffic control systems.

#### **Related Links**

- Cree SiC Schottky diode portfolio: http://www.wolfspeed.com/Power/Products#SiCSchottkyDiodes
- Schottky diode Spice models: http://www.wolfspeed.com/power/tools-and-support/DIODE-model-request2
- SiC MOSFET and diode reference designs: http://go.pardot.com/I/101562/2015-07-31/349i

Copyright © 2015 Cree, Inc. All rights reserved.

The information in this document is subject to change without notice.

Cree, the Cree logo, and Zero Recovery are registered trademarks of Cree, Inc.